

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2541	257/778.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:48
L2	1943	257/706-707.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:53
L3	917	chen.in. and industrial near2 research. as.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:55
L4	933	chen.in. and industrial adj technology research.as. and (chip or die) and heat adj sink and carrier and encapsulating	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:55
L5	0	chen.in. and industrial adj technology adj research.as. and (chip or die) and heat adj sink and carrier and encapsulating	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:56
L6	3	chen.in. and industrial adj technology adj research.as. and (chip or die) and heat adj sink and carrier	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:56
L7	3	huang.in. and industrial adj technology adj research.as. and (chip or die) and heat adj sink and carrier	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:56
L8	0	li.in. and industrial adj technology adj research.as. and (chip or die) and heat adj sink and carrier	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:56
L9	0	fukui.in. and industrial adj technology adj research.as. and (chip or die) and heat adj sink and carrier	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:57
L10	0	nemoto.in. and industrial adj technology adj research.as. and (chip or die) and heat adj sink and carrier	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:57
L11	0	flip adj chip and industrial adj technology adj research.as. and (chip or die) and heat adj sink and carrier	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:57
L12	5	flip adj chip and industrial adj technology adj research.as. and (chip or die) and heat adj sink	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 09:08

L13	23	nippon adj telegraph.as. and mems	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 09:08
L14	10	("20020117728"   "20020159170"   "20030169962"   "20040061961"   "20040156581"   "6025951"   "6597827"   "6600851"   "6704475"   "6711317").PN. OR ("6912336").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/15 09:10
S1	271	257/778.ccls. and flip adj chip and heat adj sink	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/15 08:26
S2	108	("4092697").PN. OR ("4323914"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 15:52
S3	1	"20040212080".pn. and passive	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/14 15:53
S4	94	257/778.ccls. and flip adj chip and passive same (resistor or capacitor)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/14 16:19
S5	21	257/778.ccls. and flip adj chip and passive same (resistor or capacitor) and heat adj sink	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/14 16:02
S6	2	("6825559").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/09/14 16:02
S7	2	("5192987"   "5949140").PN. OR ("6825559").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 16:02
S8	2	("6437240").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/09/14 16:09
S9	262	flip adj chip and passive same (resistor or capacitor) and heat adj sink	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/14 16:48
S10	2	("5471027").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/09/14 16:42
S11	100	flip adj chip and (encapsualting or encapsulant) near5 resin and heat adj sink	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/14 16:45

S12	147	flip adj chip and (encapsulating or encapsulant) near5 resin and heat adj sink	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/14 16:45
S13	0	flip adj chip and passive same (resistor or capacitor) and heat adj sink	IBM_TDB	OR	ON	2005/09/14 16:49
S14	261	flip adj chip and passive same (resistor or capacitor) and heat adj sink	US-PGPUB; USPAT; EPO; DERWENT	OR	ON	2005/09/14 17:23
S15	858	flip adj chip and passive same (resistor or capacitor) and "257"/\$.ccls.	US-PGPUB; USPAT; EPO; DERWENT	OR	ON	2005/09/14 17:25
S16	763	flip adj chip and passive same (resistor or capacitor) and "257"/\$.ccls. and (bump or ball)	US-PGPUB; USPAT; EPO; DERWENT	OR	ON	2005/09/14 17:26
S17	763	flip adj chip and passive same (resistor or capacitor) and "257"/\$.ccls. and (bump or ball)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/09/14 17:26
S18	12	("5450283"   "5784261"   "5895229"   "5981314"   "5998243"   "6038136"   "6048483"   "6049122"   "6071755"   "6081997"   "6187243"   "6344162"). PN. OR ("6632704").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 17:30